# **BFU725F/N1**

## NPN wideband silicon germanium RF transistor

Rev. 01 — 13 July 2009

**Product data sheet** 

### 1. Product profile

#### 1.1 General description

NPN silicon germanium microwave transistor for high speed, low noise applications in a plastic, 4-pin dual-emitter SOT343F package.

#### CAUTION



This device is sensitive to ElectroStatic Discharge (ESD). Observe precautions for handling electrostatic sensitive devices.

Such precautions are described in the ANSI/ESD S20.20, IEC/ST 61340-5, JESD625-A or equivalent standards.

#### 1.2 Features

- Low noise high gain microwave transistor
- Noise figure (NF) = 0.7 dB at 5.8 GHz
- High maximum stable gain 27 dB at 1.8 GHz
- 110 GHz f<sub>T</sub> silicon germanium technology

#### 1.3 Applications

- 2nd LNA stage and mixer stage in DBS LNB's
- Satellite radio
- Low noise amplifiers for microwave communications systems
- WLAN and CDMA applications
- Analog/digital cordless applications
- Ka band oscillators (DRO's)

#### 1.4 Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
$V_{\text{CBO}}$	collector-base voltage	open emitter		-	-	10	V
$V_{CEO}$	collector-emitter voltage	open base		-	-	2.8	V
$V_{EBO}$	emitter-base voltage	open collector		-	-	0.55	V
I <sub>C</sub>	collector current			-	25	40	mA
P <sub>tot</sub>	total power dissipation	$T_{sp} \le 90  ^{\circ}C$	[1]	-	-	136	mW
h <sub>FE</sub>	DC current gain	$I_C = 10 \text{ mA}; V_{CE} = 2 \text{ V};$ $T_i = 25  ^{\circ}\text{C}$		160	280	400	





Table 1. Quick reference data ...continued

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$C_{CBS}$	collector-base capacitance	$V_{CB} = 2 V; f = 1 MHz$	-	70	-	fF
f <sub>T</sub>	transition frequency	$I_C = 25 \text{ mA}; V_{CE} = 2 \text{ V};$ f = 2 GHz; $T_{amb} = 25 ^{\circ}\text{C}$	-	55	-	GHz
$G_{p(max)}$	maximum power gain	$I_C$ = 25 mA; $V_{CE}$ = 2 V; f = 5.8 GHz; $T_{amb}$ = 25 °C	[2] _	18	-	dB
NF	noise figure	$I_C$ = 5 mA; $V_{CE}$ = 2 V; f = 5.8 GHz; $\Gamma_S$ = $\Gamma_{opt}$ ; $\Gamma_{amb}$ = 25 °C	-	0.7	-	dB

<sup>[1]</sup>  $T_{sp}$  is the temperature at the solder point of the emitter lead.

## 2. Pinning information

Table 2. Discrete pinning

Pin	Description	Simplified outline	Graphic symbol
1	emitter		
2	base	3 4	4
3	emitter		2
4	collector		' ` ` `
		2 1	1, 3 mbb159
		2 1	11100139

## 3. Ordering information

Table 3. Ordering information

Type number	Package				
	Name	Description	Version		
BFU725F/N1	-	plastic surface-mounted flat pack package; reverse pinning; 4 leads	SOT343F		

## 4. Marking

Table 4. Marking

Type number	Marking	Description
BFU725F/N1	B7*	* = p : made in Hong Kong
		* = t : made in Malaysia
		* = W : made in China

 $<sup>\</sup>label{eq:Gpmax} \mbox{[2]} \quad \mbox{$G_{p(max)}$ is the maximum power gain, if $K > 1$. If $K < 1$ then $G_{p(max)}$ = Maximum Stable Gain (MSG).}$ 

## 5. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

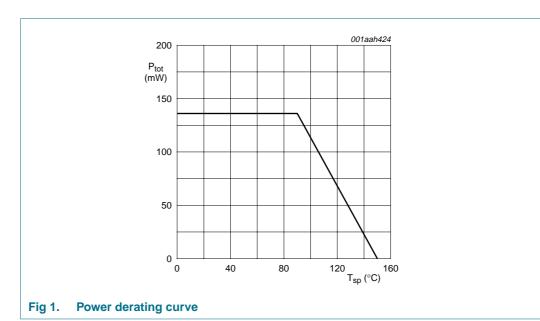
Symbol	Parameter	Conditions	Min	Max	Unit
$V_{CBO}$	collector-base voltage	open emitter	-	10	V
$V_{CEO}$	collector-emitter voltage	open base	-	2.8	V
$V_{EBO}$	emitter-base voltage	open collector	-	0.55	V
I <sub>C</sub>	collector current		-	40	mA
P <sub>tot</sub>	total power dissipation	$T_{sp} \le 90  ^{\circ}C$	<u>[1]</u> _	136	mW
T <sub>stg</sub>	storage temperature		-65	+150	°C
Tj	junction temperature		-	150	°C

<sup>[1]</sup>  $T_{sp}$  is the temperature at the solder point of the emitter lead.

### 6. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions	Тур	Unit
$R_{th(j-sp)}$	thermal resistance from junction to solder point		440	K/W



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## 7. Characteristics

Table 7. Characteristics

 $T_i = 25 \,^{\circ}C$  unless otherwise specified.

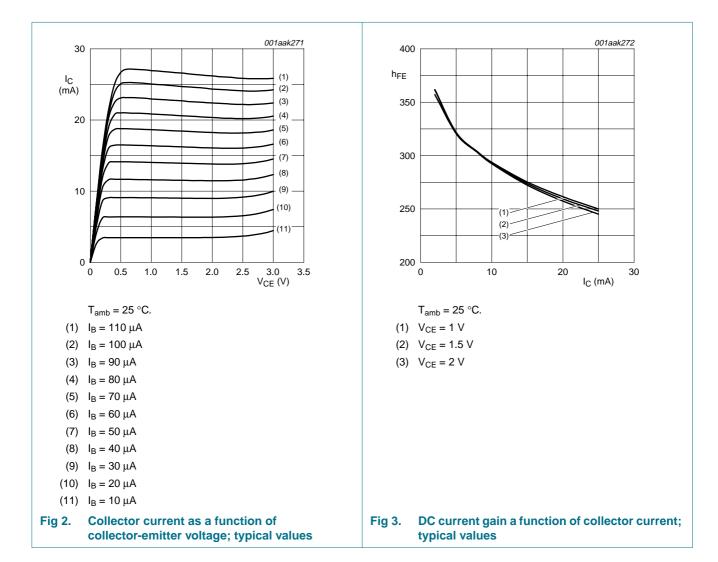
Voltage Voltage Collector-emitter breakdown voltage Ic = 1 mA; I <sub>B</sub> = 0 mA 2.8 - V V   CC collector current - 2.5 40 mA   CBO collector current I <sub>E</sub> = 0 mA; V <sub>CB</sub> = 4.5 V - - - 100 nA   CBO collector-base cut-off current I <sub>E</sub> = 0 mA; V <sub>CB</sub> = 2 V; f = 1 MHz - - 2.6 400 nA - - 100 nA - - 100 nA - - 100 nA - - 100 nA - - - 100 nA - - - 100 nA - - - - - - - - - - - - - - - - - - - - - - - - - - - - - - - - - - - -	Symbol	Parameter	Conditions	Min	Тур	Max	Unit
CC collector current I <sub>E</sub> = 0 mA; V <sub>CB</sub> = 4.5 V - 2.5 40 mA   CBD collector-base cut-off current I <sub>E</sub> = 0 mA; V <sub>CB</sub> = 4.5 V 160 280 400 NA   CBD DC current gain I <sub>C</sub> = 10 mA; V <sub>CB</sub> = 2 V 160 280 400 F   CBBS emitter-base capacitance V <sub>CB</sub> = 2 V; f = 1 MHz - 260 - fF   CBBS collector-base capacitance V <sub>CB</sub> = 2 V; f = 1 MHz - 70 - fF   CBBS collector-base capacitance V <sub>CB</sub> = 2 V; f = 1 MHz - 70 - fF   CBBS collector-base capacitance V <sub>CB</sub> = 2 V; f = 1 MHz - 70 - fF   CBBS collector-base capacitance V <sub>CB</sub> = 2 V; f = 1 MHz - 70 - GHz   CBBS collector-base capacitance V <sub>CB</sub> = 2 V; f = 1 MHz - 28 dB GHz G	$V_{(BR)CBO}$		$I_C = 2.5 \mu A; I_E = 0 \text{ mA}$	10	-	-	V
Code collector-base cut-off current I <sub>E</sub> = 0 mA; V <sub>CB</sub> = 4.5 V - - 100 nA   Code DC current gain I <sub>C</sub> = 10 mA; V <sub>CB</sub> = 2 V 160 280 400   Codes collector-emitter capacitance V <sub>CB</sub> = 2 V; f = 1 MHz - 268 - F   Codes collector-base capacitance V <sub>CB</sub> = 0.5 V; f = 1 MHz - 70 - F   Codes collector-base capacitance V <sub>CB</sub> = 2 V; f = 1 MHz - 70 - F   Codes collector-base capacitance V <sub>CB</sub> = 2 V; f = 1 MHz - 70 - F   T transition frequency I <sub>C</sub> = 25 mA; V <sub>CE</sub> = 2 V; f = 2 GHz; T <sub>amb</sub> = 25 °C 10 - F CHz <t< td=""><td><math>V_{(BR)CEO}</math></td><td></td><td><math>I_C = 1 \text{ mA}</math>; <math>I_B = 0 \text{ mA}</math></td><td>2.8</td><td>-</td><td>-</td><td>V</td></t<>	$V_{(BR)CEO}$		$I_C = 1 \text{ mA}$ ; $I_B = 0 \text{ mA}$	2.8	-	-	V
$ \begin{array}{cccccccccccccccccccccccccccccccccccc$	Ic	collector current		-	25	40	mA
	I <sub>CBO</sub>	collector-base cut-off current	$I_E = 0 \text{ mA}; V_{CB} = 4.5 \text{ V}$	-	-	100	nA
EBBS emitter-base capacitance V <sub>EB</sub> = 0.5 V; f = 1 MHz - 400	h <sub>FE</sub>	DC current gain	$I_C = 10 \text{ mA}; V_{CE} = 2 \text{ V}$	160	280	400	
$ \begin{array}{cccccccccccccccccccccccccccccccccccc$	C <sub>CES</sub>	collector-emitter capacitance	$V_{CB} = 2 \text{ V}; f = 1 \text{ MHz}$	-	268	-	fF
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	C <sub>EBS</sub>	emitter-base capacitance	$V_{EB} = 0.5 \text{ V; } f = 1 \text{ MHz}$	-	400	-	fF
Permany maximum power gain Ic = 25 mA; VcE = 2 V; Tamb = 25 °C 10   f = 1.5 GHz - 28 - dB - dB   f = 1.8 GHz - 25.5 - dB - dB   f = 2.4 GHz - 18 - dB - dB   f = 5.8 GHz - 18 - dB - dB   f = 12 GHz - 13 - dB - dB   s21]² Insertion power gain Ic = 25 mA; VcE = 2 V; Tamb = 25 °C - 26.7 - dB   f = 1.5 GHz - 26.7 - dB - dB   f = 1.8 GHz - 26.7 - dB - dB   f = 2.4 GHz - 25.4 - dB - dB   f = 2.4 GHz - 26.7 - dB - dB   f = 1.8 GHz - 0.42 - dB - dB   f = 1.5 GHz - 0.42 - dB - dB   f = 2.4 GHz - 0.42 - dB - dB   f = 2.4 GHz - 0.42 - dB - dB   f = 2.4 GHz - 0.42 - dB - dB   f = 5.8 GHz - 0.42 - dB - dB   f = 1.2 GHz - 0.42 - dB - dB   f = 1.8 GHz - 0.42 - dB - dB   f = 1.2 GHz - 0.	C <sub>CBS</sub>	collector-base capacitance	$V_{CB} = 2 \text{ V; } f = 1 \text{ MHz}$	-	70	-	fF
	f <sub>T</sub>	transition frequency	$I_C$ = 25 mA; $V_{CE}$ = 2 V; f = 2 GHz; $T_{amb}$ = 25 °C	-	55	-	GHz
	G <sub>p(max)</sub>	maximum power gain	$I_C = 25 \text{ mA}; V_{CE} = 2 \text{ V}; T_{amb} = 25 \text{ °C}$				
$ \begin{array}{c} f = 2.4  \text{GHz} & - & 25.5 & - & dB \\ f = 5.8  \text{GHz} & - & 18 & - & dB \\ f = 12  \text{GHz} & - & 13 & - & dB \\ \hline f = 12  \text{GHz} & - & 13 & - & dB \\ \hline s_{21} ^2 & \text{insertion power gain} & I_{C} = 25  \text{mA; V}_{CE} = 2  \text{V; T}_{amb} = 25  ^{\circ}\text{C} \\ \hline f = 1.5  \text{GHz} & - & 25.4 & - & dB \\ f = 1.8  \text{GHz} & - & 25.4 & - & dB \\ f = 2.4  \text{GHz} & - & 25.4 & - & dB \\ f = 2.4  \text{GHz} & - & 23 & - & dB \\ f = 5.8  \text{GHz} & - & 16 & - & dB \\ f = 12  \text{GHz} & - & 9.3 & - & dB \\ \hline f = 12  \text{GHz} & - & 0.42 & - & dB \\ \hline f = 1.5  \text{GHz} & - & 0.42 & - & dB \\ f = 1.8  \text{GHz} & - & 0.43 & - & dB \\ \hline f = 2.4  \text{GHz} & - & 0.47 & - & dB \\ \hline f = 2.4  \text{GHz} & - & 0.47 & - & dB \\ \hline f = 2.4  \text{GHz} & - & 0.47 & - & dB \\ \hline f = 2.4  \text{GHz} & - & 0.47 & - & dB \\ \hline f = 1.8  \text{GHz} & - & 0.47 & - & dB \\ \hline f = 1.8  \text{GHz} & - & 0.47 & - & dB \\ \hline f = 1.8  \text{GHz} & - & 0.47 & - & dB \\ \hline f = 1.8  \text{GHz} & - & 0.47 & - & dB \\ \hline f = 1.8  \text{GHz} & - & 0.47 & - & dB \\ \hline f = 1.8  \text{GHz} & - & 0.47 & - & dB \\ \hline f = 1.8  \text{GHz} & - & 0.47 & - & dB \\ \hline f = 1.8  \text{GHz} & - & 0.47 & - & dB \\ \hline f = 1.8  \text{GHz} & - & 0.47 & - & dB \\ \hline f = 1.8  \text{GHz} & - & 0.47 & - & dB \\ \hline f = 1.8  \text{GHz} & - & 0.47 & - & dB \\ \hline f = 1.8  \text{GHz} & - & 0.47 & - & dB \\ \hline f = 1.8  \text{GHz} & - & 0.47 & - & dB \\ \hline f = 1.8  \text{GHz} & - & 0.47 & - & dB \\ \hline f = 1.8  \text{GHz} & - & 0.47 & - & dB \\ \hline f = 1.8  \text{GHz} & - & 0.47 & - & dB \\ \hline f = 1.8  \text{GHz} & - & 0.47 & - & dB \\ \hline f = 1.8  \text{GHz} & - & 0.47 & - & dB \\ \hline f = 1.8  \text{GHz} & - & 0.47 & - & dB \\ \hline f = 1.8  \text{GHz} & - & 0.47 & - & dB \\ \hline f = 1.8  \text{GHz} & - & 0.47 & - & dB \\ \hline f = 1.8  \text{GHz} & - & 0.47 & - & dB \\ \hline f = 1.8  \text{GHz} & - & 0.47 & - & dB \\ \hline f = 1.8  \text{GHz} & - & 0.47 & - & dB \\ \hline f = 1.8  \text{GHz} & - & 0.47 & - & dB \\ \hline f = 1.8  \text{GHz} & - & 0.47 & - & dB \\ \hline f = 1.8  \text{GHz} & - & 0.47 & - & dB \\ \hline f = 1.8  \text{GHz} & - & 0.47 & - & 0.47 & - & dB \\ \hline f = 1.8  \text{GHz} & - & 0.47 & - & 0.47 & - & dB \\ \hline f = 1.8  \text{GHz} & - & 0.47 & - & 0.47 & - & 0.47 \\ \hline f $			f = 1.5 GHz	-	28	-	dB
			f = 1.8 GHz	-	27	-	dB
F = 12 GHz			f = 2.4 GHz	-	25.5	-	dB
			f = 5.8 GHz	-	18	-	dB
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$			f = 12 GHz	-	13	-	dB
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	s <sub>21</sub>   <sup>2</sup>	insertion power gain	$I_C$ = 25 mA; $V_{CE}$ = 2 V; $T_{amb}$ = 25 °C				
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$			f = 1.5 GHz	-	26.7	-	dB
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$			f = 1.8 GHz	-	25.4	-	dB
$ \begin{array}{c} & & & & \\ & & & \\ & & \\ & & \\ & & \\ & & \\ & & \\ & & \\ & & \\ & & \\ & & \\ & & \\ & & \\ & & \\ & & \\ & & \\ & & \\ & & \\ & & \\ & & \\ & & \\ & & \\ & & \\ & & \\ & \\ & & \\ & \\ & & \\ & \\ & \\ & \\ & & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & $			f = 2.4 GHz	-	23	-	dB
NF noise figure			f = 5.8 GHz	-	16	-	dB
$ \begin{array}{cccccccccccccccccccccccccccccccccccc$			f = 12 GHz	-	9.3	-	dB
$ \begin{array}{cccccccccccccccccccccccccccccccccccc$	NF	noise figure	$I_C$ = 5 mA; $V_{CE}$ = 2 V; $\Gamma_S$ = $\Gamma_{opt}$ ; $T_{amb}$ = 25 °C				
$ \begin{array}{cccccccccccccccccccccccccccccccccccc$			f = 1.5 GHz	-	0.42	-	dB
$ \begin{array}{cccccccccccccccccccccccccccccccccccc$			f = 1.8 GHz	-	0.43	-	dB
$ \begin{array}{cccccccccccccccccccccccccccccccccccc$			f = 2.4 GHz	-	0.47	-	dB
$ \begin{array}{cccccccccccccccccccccccccccccccccccc$			f = 5.8 GHz	-	0.7	-	dB
$\begin{array}{cccccccccccccccccccccccccccccccccccc$			f = 12 GHz	-	1.1	-	dB
$ f = 1.5 \text{ GHz} & - 24 - dB \\ f = 1.8 \text{ GHz} & - 22 - dB \\ f = 2.4 \text{ GHz} & - 20 - dB \\ f = 5.8 \text{ GHz} & - 13.5 - dB \\ $	G <sub>ass</sub>	associated gain	$I_C$ = 5 mA; $V_{CE}$ = 2 V; $\Gamma_S$ = $\Gamma_{opt}$ ; $T_{amb}$ = 25 °C				
f = 2.4  GHz - 20 - dB f = 5.8  GHz - 13.5 - dB			·	-	24	-	dB
f = 5.8  GHz - 13.5 - dB			f = 1.8 GHz	-	22	-	dB
f = 5.8  GHz - 13.5 - dB			f = 2.4 GHz	-	20	-	dB
f = 12 GHz - 10 - dR			f = 5.8 GHz	-	13.5	-	dB
1 = 12 S112			f = 12 GHz	-	10	-	dB

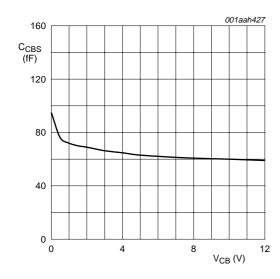


**Table 7.** Characteristics ... continued  $T_i = 25 \,^{\circ}$ C unless otherwise specified.

I <sub>j</sub> = 25 °C uniess otherwise specified.						
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
P <sub>L(1dB)</sub> output power at 1 dB gain		$I_{C}$ = 25 mA; $V_{CE}$ = 2 V; $Z_{S}$ = $Z_{L}$ = 50 $\Omega$ ; $T_{amb}$ = 25 °C				
compression	compression	f = 1.5 GHz	-	8.5	-	dBm
		f = 1.8 GHz	-	9	-	dBm
		f = 2.4 GHz	-	8.5	-	dBm
		f = 5.8 GHz	-	8	-	dBm
IP3	third-order intercept point	$I_C$ = 25 mA; $V_{CE}$ = 2 V; $Z_S$ = $Z_L$ = 50 $\Omega$ ; $T_{amb}$ = 25 °C; $f_2$ = $f_1$ + 1 MHz				
		f <sub>1</sub> = 1.5 GHz	-	17	-	dBm
		f <sub>1</sub> = 1.8 GHz	-	17	-	dBm
		f <sub>1</sub> = 2.4 GHz	-	17	-	dBm
		f <sub>1</sub> = 5.8 GHz	-	19	-	dBm

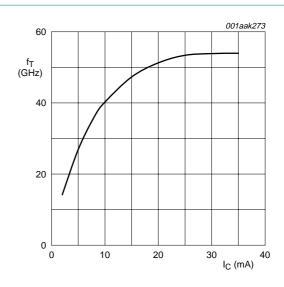
[1]  $G_{p(max)}$  is the maximum power gain, if K > 1. If K < 1 then  $G_{p(max)} = MSG$ .





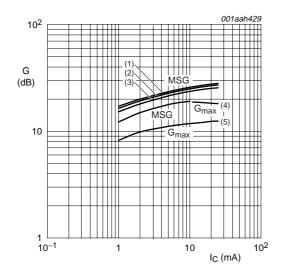
 $f = 1 \text{ MHz}, T_{amb} = 25 \,^{\circ}\text{C}.$ 

Fig 4. Collector-base capacitance as a function of collector-base voltage; typical values



 $V_{CE} = 2 \text{ V}$ ; f = 2 GHz;  $T_{amb} = 25 \, ^{\circ}\text{C}$ .

Fig 5. Transition frequency as a function of collector current; typical values



 $V_{CE} = 2 \text{ V}; T_{amb} = 25 \,^{\circ}\text{C}.$ 

(1) f = 1.5 GHz

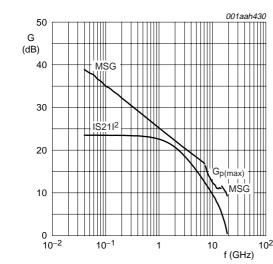
(2) f = 1.8 GHz

(3) f = 2.4 GHz

(4) f = 5.8 GHz

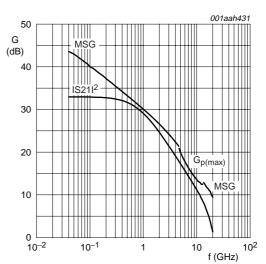
(5) f = 12 GHz

Fig 6. Gain as a function of collector current; typical value



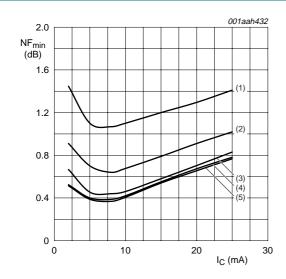
 $V_{CE}$  = 2 V;  $I_{C}$  = 5 mA;  $T_{amb}$  = 25 °C.

Gain as a function of frequency; typical values



 $V_{CE}$  = 2 V;  $I_{C}$  = 25 mA;  $T_{amb}$  = 25 °C.

Gain as a function of frequency; typical values Fig 8.



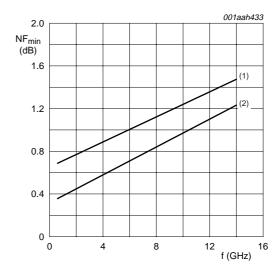
 $V_{CE}$  = 2 V;  $T_{amb}$  = 25 °C.

(1) f = 12 GHz

Fig 7.

- (2) f = 5.8 GHz
- (3) f = 2.4 GHz
- (4) f = 1.8 GHz
- (5) f = 1.5 GHz

Minimum noise figure as a function of Fig 9. collector current; typical values



 $V_{CE} = 2 \text{ V}$ ;  $T_{amb} = 25 \, ^{\circ}\text{C}$ .

- (1)  $I_C = 25 \text{ mA}$
- (2)  $I_C = 5 \text{ mA}$

Fig 10. Minimum noise figure as a function of frequency; typical values

## 8. Package outline

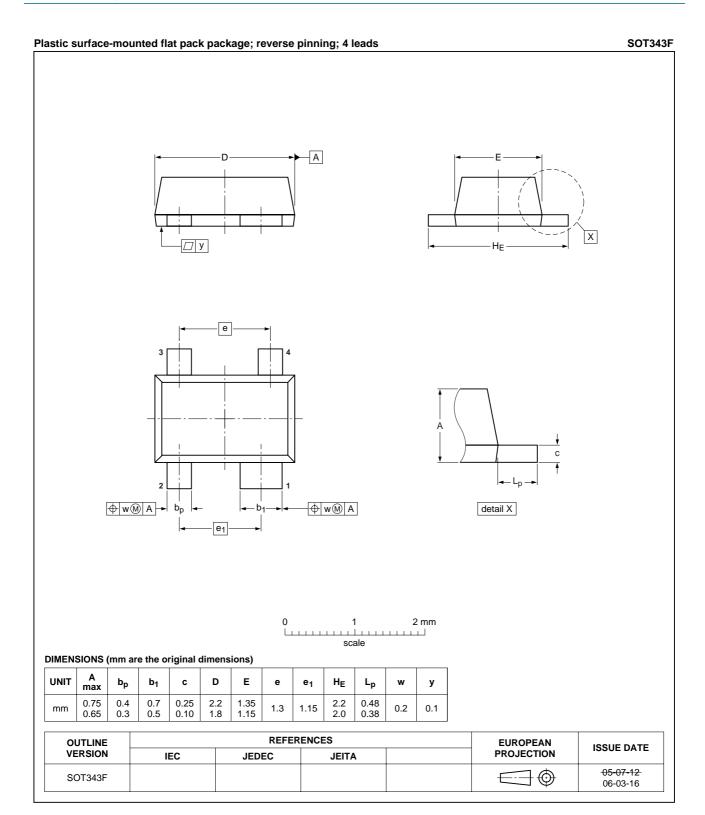


Fig 11. Package outline SOT343F



### 9. Abbreviations

Table 8. Abbreviations

Acronym	Description
CDMA	Code Division Multiple Access
DBS	Direct Broadcast Satellite
DC	Direct Current
DRO	Dielectric Resonator Oscillator
LNA	Low Noise Amplifier
LNB	Low Noise Block
Ka	Kurtz above
NPN	Negative-Positive-Negative
RF	Radio Frequency
WLAN	Wireless Local Area Network

## 10. Revision history

#### Table 9. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BFU725F_N1_1	20090713	Product data sheet	-	-



### 11. Legal information

#### 11.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
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